

CLAIMS

What Is Claimed Is:

- 1 1. A method for positioning a tunneling tip at a spacing of one nanometer from a  
2 conducting surface comprising the steps of:  
3 depositing a quantity of fullerene C<sub>60</sub> on the conducting surface;  
4 removing all but a monolayer film of fullerene C<sub>60</sub> on the conducting  
5 surface;  
6 applying an electrical bias to the tunneling tip;  
7 moving the tunneling tip toward the conducting surface with the  
8 fullerene C<sub>60</sub> film between the tunneling tip and the conducting surface;  
9 monitoring for conductance between the tunneling tip and the fullerene  
10 C<sub>60</sub> film; and  
11 fixing the position of the tunneling tip with respect to the conducting  
12 surface when a said monitoring indicates that the tunneling tip is in contact  
13 with the fullerene C<sub>60</sub> film.

1 2. A removable packaging method for establishing a one nanometer spacing  
2 between electrically conducting components comprising the steps of:

3 depositing a monolayer of  $C_{60}$  fullerene on a first fixed conductive  
4 surface;

5 moving a second conductive surface with an electrical bias adjacent to  
6 the first conductive surface at a location where current is transferred to the  
7 monolayer of  $C_{60}$  fullerene;

8 breaking down the fullerene  $C_{60}$  into carbonaceous byproducts;

9 introducing a gas selected to react with the carbonaceous byproducts to  
10 form a stable molecular gas; and

11 providing a sacrificial surface to selectively adsorb the stable  
12 molecular gas.

1 3. A method for inhibiting contact between a tunneling tip and a conducting  
2 substrate comprising the steps of:

3 depositing a monolayer of fullerene  $C_{60}$  on the conducting substrate;

4 providing the tunneling tip with an electrical bias;

5 moving the tunneling tip to a position adjacent the conducting substrate  
6 and fixing the tunneling tip position with respect to the conducting substrate  
7 when an electrical current is detected in the fullerene  $C_{60}$  monolayer due to the  
8 presence of the tunneling tip;

9 energizing the monolayer of fullerene  $C_{60}$  to breakup the monolayer

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10 into carbonous byproducts; and  
11 removing the carbonous byproducts, leaving the tunneling tip fixed at  
12 said fixed position.

1 4. A method for separating an electron-donating tunneling surface from an  
2 electron-receiving surface at a distance of on nanometer comprising the steps of:  
3 establishing a monolayer of fullerene on the electron-receiving surface,  
4 where said fullerene has a monolayer thickness of one nanometer;  
5 providing an electrical bias on the electron-donating tunneling surface;  
6 bringing the electron-donating tunneling surface into contact with the  
7 monolayer of fullerene on the electron-receiving surface; and  
8 establishing an electrical current between the electron-donating  
9 tunneling surface and the electron-receiving surface, said electrical current  
10 communicating across the monolayer of fullerene.

1 5. A method for manufacturing a MEMS device with a protective coating  
2 comprising the steps of:  
3 depositing via sublimation a fullerene layer onto a gold surface of a  
4 conducting substrate;  
5 providing an electrical bias on a gold-plated tunneling tip;  
6 moving the tunneling tip towards the conducting substrate, and monitoring the

15 adsorbing the carbon based gas onto a prefabricated sacrificial surface leaving  
16 a region adjacent the tunneling tip free of fullerene and fullerene byproducts.

6. A carbon based protective padding for a MEMS device, the carbon based protective padding further adapted to accurately and reliably establish a one nanometer spacing between a conducting surface on the MEMS device and a tunneling tip, the carbon based protective padding comprising a film of fullerene C<sub>60</sub> having a thickness of one molecule, said film located at the conducting surface between the tunneling tip and the conducting surface.

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